

MOS FIELD EFFECT TRANSISTOR

NP80N03CLE,NP80N03DLE,NP80N03ELE NP80N03KLE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Channel Temperature 175 degree rated
- Super Low On-state Resistance $R_{DS(on)1} = 7.0 \text{ m}\Omega$ MAX. (Vgs = 10 V, ID = 40 A) $R_{DS(on)2} = 9.0 \text{ m}\Omega$ MAX. (Vgs = 5 V, ID = 40 A)
- Low Ciss : Ciss = 2600 pF TYP.
- Built-in Gate Protection Diode

ORDERING INFORMATION

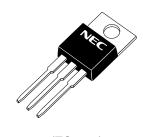
PART NUMBER	PACKAGE
NP80N03CLE	TO-220AB
NP80N03DLE	TO-262
NP80N03ELE	TO-263 (MP-25ZJ)
NP80N03KLE	TO-263 (MP-25ZK)

(TO-220AB)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vss = 0 V)	VDSS	30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC) Note1	ID(DC)	±80	Α
Drain Current (Pulse) Note2	ID(pulse)	±320	Α
Total Power Dissipation (T _A = 25°C)	Рт	1.8	W
Total Power Dissipation (Tc = 25°C)	Рт	120	W
Channel Temperature	Tch	175	°C
Storage Temperature	T _{stg}	-55 to +175	°C
Single Avalanche Current Note3	las	50 / 40 / 9	Α
Single Avalanche Energy Note3	Eas	2.5 / 160 / 400	mJ

- **Notes 1.** Calculated constant current according to MAX. allowable channel temperature.
 - **2.** PW \leq 10 μ s, Duty cycle \leq 1%
 - 3. Starting Tch = 25°C, Rg = 25 Ω , Vgs = 20 \rightarrow 0 V (see Figure 4.)



(TO-262)



(TO-263)



THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	1.25	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

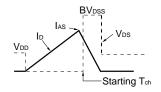
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ELECTRICAL CHARACTERISTICS (TA = 25°C)

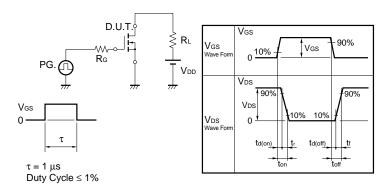
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	Vps = 30 V, Vgs = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Gate to Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 40 A	20	41		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 40 A		5.3	7.0	mΩ
	RDS(on)2	Vgs = 5 V, ID = 40 A		6.8	9.0	mΩ
	RDS(on)3	Vgs = 4.5 V, ID = 40 A		7.5	11	mΩ
Input Capacitance	Ciss	Vps = 25 V		2600	3900	pF
Output Capacitance	Coss	Vgs = 0 V		590	890	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		270	490	pF
Turn-on Delay Time	t _{d(on)}	VDD = 15 V, ID = 40 A		20	44	ns
Rise Time	tr	Vgs = 10 V		12	31	ns
Turn-off Delay Time	t _{d(off)}	$R_G = 1 \Omega$		60	120	ns
Fall Time	t f			14	35	ns
Total Gate Charge 1	Q _{G1}	VDD = 24 V, VGS = 10 V, ID = 80 A		48	72	nC
Total Gate Charge 2	Q _{G2}	V _{DD} = 24 V		28	42	nC
Gate to Source Charge	Qgs	Vgs = 5 V		10		nC
Gate to Drain Charge	Q _{GD}	ID = 80 A		14		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 80 A, Vgs = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 80 A, Vgs = 0 V		34		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		22		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{Rg} = 25 \Omega \\ \text{Vgs} = 20 \rightarrow 0 \text{V} \end{array} \begin{array}{c} \text{D.U.T.} \\ \text{So} \Omega \\ \text{V} \end{array} \begin{array}{c} \text{D.U.T.} \\ \text{O.U.T.} \\ \text{Volume} \end{array}$



TEST CIRCUIT 2 SWITCHING TIME



TEST CIRCUIT 3 GATE CHARGE

TYPICAL CHARACTERISTICS (TA = 25°C)



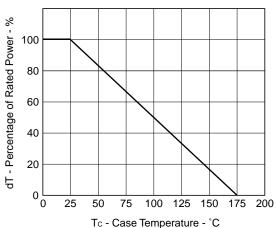


Figure 3. FORWARD BIAS SAFE OPERATING AREA

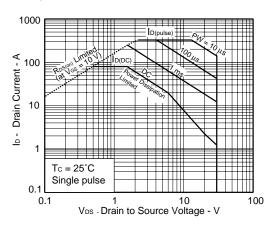


Figure2. TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

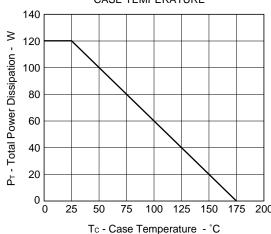


Figure4. SINGLE AVALANCHE ENERGY DERATING FACTOR

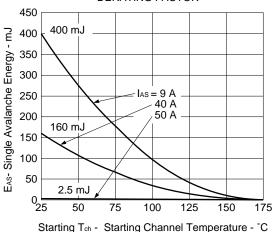
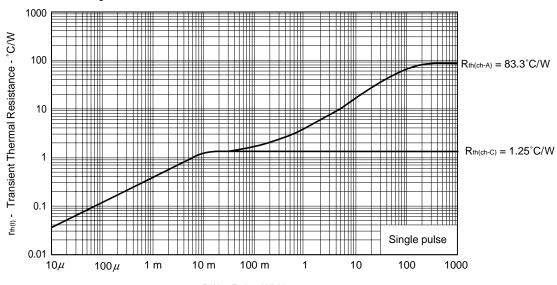


Figure 5. TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



PW - Pulse Width - s

Figure 6. FORWARD TRANSFER CHARACTERISTICS

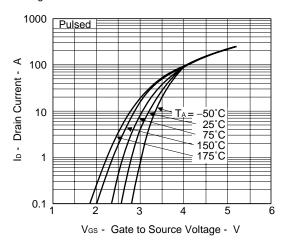


Figure 8. FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

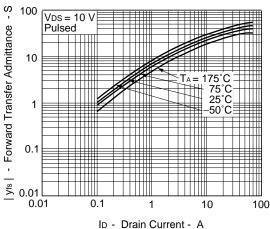


Figure 10. DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

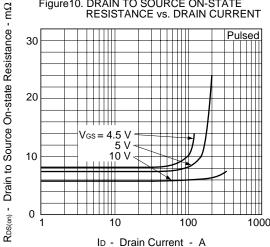


Figure 7. DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

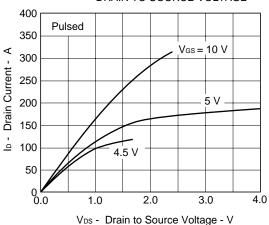


Figure 9. DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

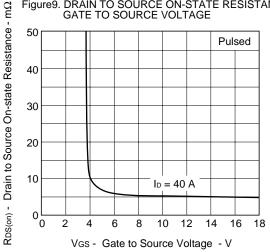
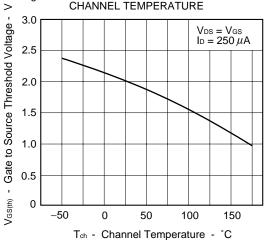
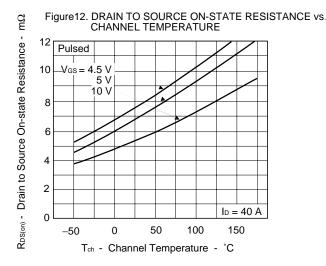
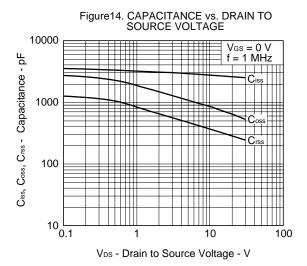
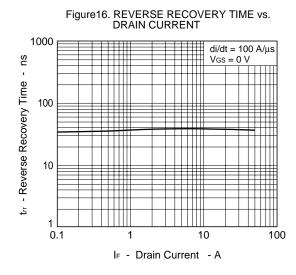


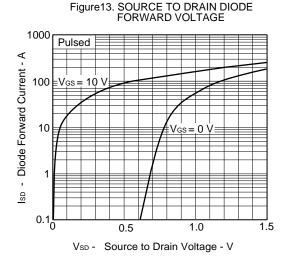
Figure 11. GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

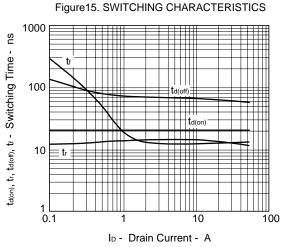


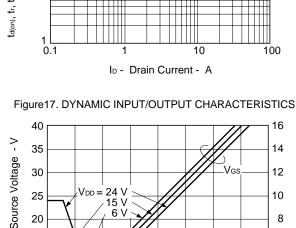






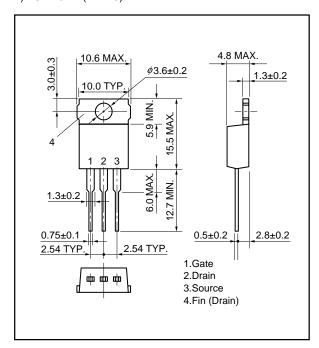




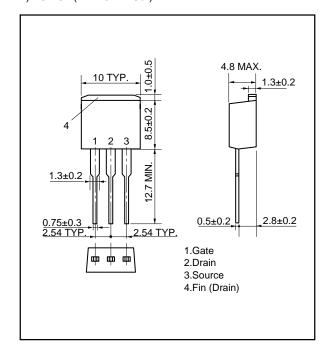


PACKAGE DRAWINGS (Unit: mm)

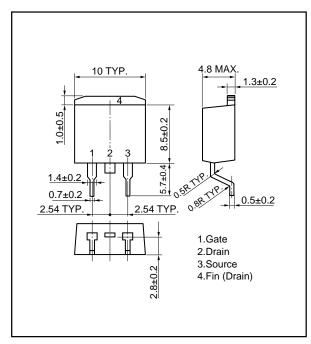
1) TO-220AB (MP-25)



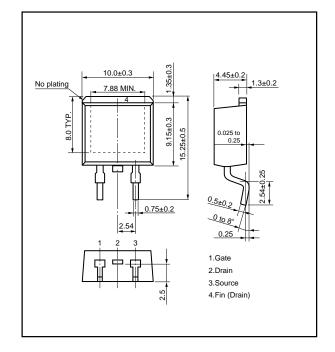
2) TO-262 (MP-25 Fin Cut)



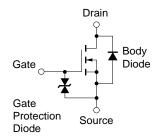
3) TO-263 (MP-25ZJ)



★ 4) TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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